

MOSFET

OptiMOS[™] 5 Power-Transistor, 40 V

Features

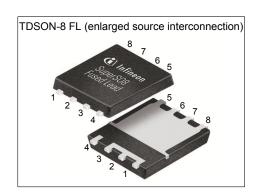
- Battery powered application
- LV motor drives
- Very low on-resistance R_{DS(on)}
- 100% avalanche tested
- Superior thermal resistance
- N-channel
- Pb-free lead plating; RoHS compliantHalogen-free according to IEC61249-2-21
- 175 °C rated

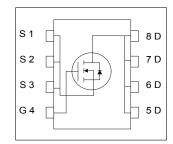
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	40	V
R _{DS(on),max}	3.6	mΩ
I _D	98	A
Qoss	22	nC
Q _G (0V10V)	21	nC











Type / Ordering Code	Package	Marking	Related Links
ISC036N04NM5	TDSON-8 FL	36N04NM5	-

OptiMOSTM 5 Power-Transistor, 40 V



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OptiMOS[™] 5 Power-Transistor, 40 V ISC036N04NM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	Counch of		Value	S		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - - -	- - - -	98 69 88 62 21	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =7 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =7 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =50 °C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	392	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	40	mJ	I_D =45 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	63 3.0	W	T _C =25 °C T _A =25 °C, R _{THJA} =50 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
raiailietei	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	2.4	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Device on PCB, 6 cm² cooling area	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher Tcase please refer to Diagram 2. De-rating will be required based on the actual environmental

conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter.			Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	40	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.2	-	3.4	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=23\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =40 V, V _{GS} =0 V, T _j =25 °C V _{DS} =40 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	2.7 3.1	3.6 4.4	mΩ	V _{GS} =10 V, I _D =49 A V _{GS} =7 V, I _D =49 A
Gate resistance	R _G	-	2.8	4.3	Ω	-
Transconductance	g_{fs}	-	140	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 49 A$

Table 5 **Dynamic characteristics**

Damamadan	Ob. a.l.	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C _{iss}	-	1500	2000	pF	V _{GS} =0 V, V _{DS} =20 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	540	700	pF	V _{GS} =0 V, V _{DS} =20 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	53	93	pF	V _{GS} =0 V, V _{DS} =20 V, f=1 MHz
Turn-on delay time	t _{d(on)}	-	5	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	2	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	8	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	4	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

	Oh. a.l.		Values			N / / T / A D 1111	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	7	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =49 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge at threshold	$Q_{g(th)}$	-	4	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =49 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge ¹⁾	$Q_{ m gd}$	-	4	6	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =49 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q _{sw}	-	7	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =49 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ¹⁾	Qg	-	21	28	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =49 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	4.5	-	V	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =49 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total, sync. FET	Q _{g(sync)}	-	19	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V	
Output charge	Qoss	-	22	-	nC	V _{DD} =20 V, V _{GS} =0 V	

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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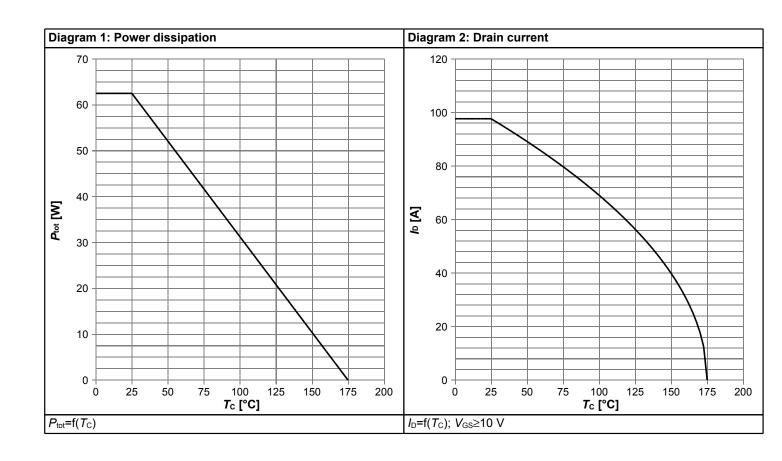


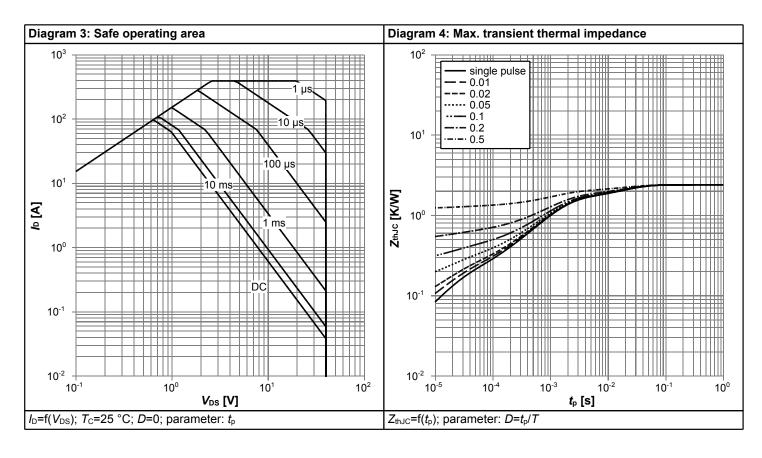
Table 7 Reverse diode

Dovomotor	Symbol		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	63	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	392	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.89	1	V	V _{GS} =0 V, I _F =49 A, T _j =25 °C	
Reverse recovery time	t _{rr}	-	35	-	ns	V_R =20 V, I_F =50 A, di_F/dt =100 A/ μ s	
Reverse recovery charge	Qrr	-	23	-	nC	V_R =20 V, I_F =50 A, di_F/dt =100 A/ μ s	

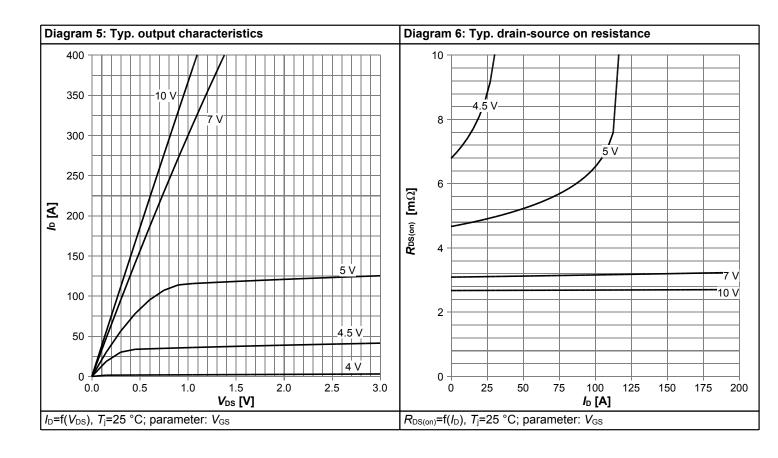


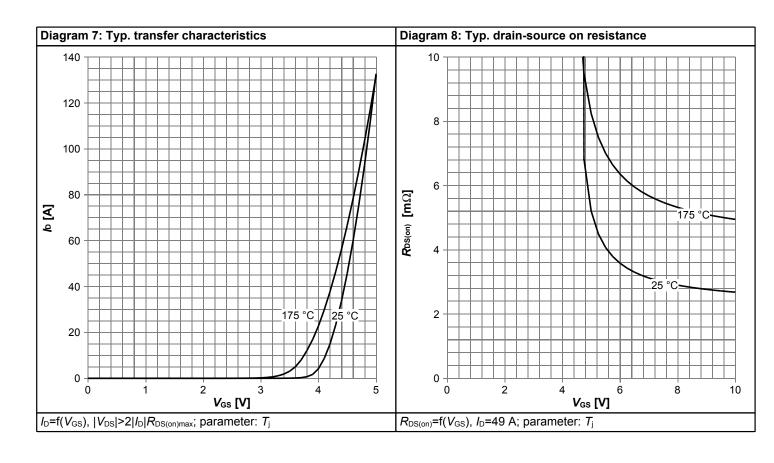
4 Electrical characteristics diagrams



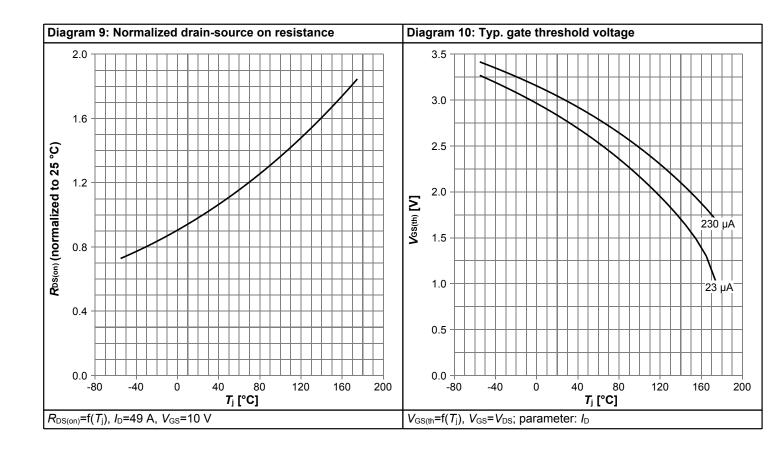


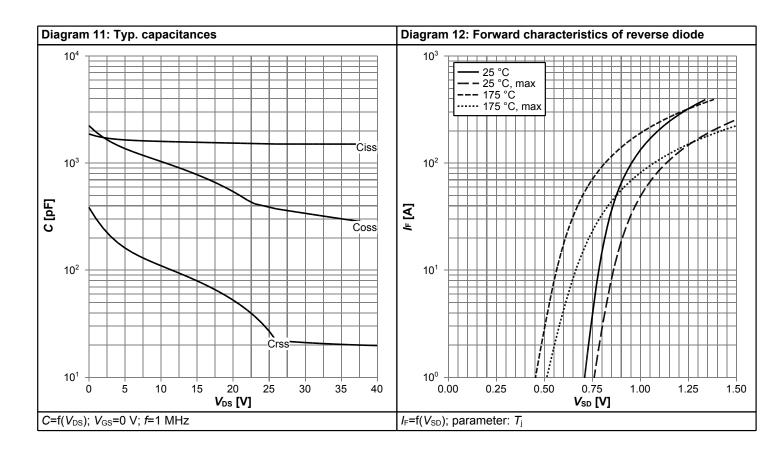




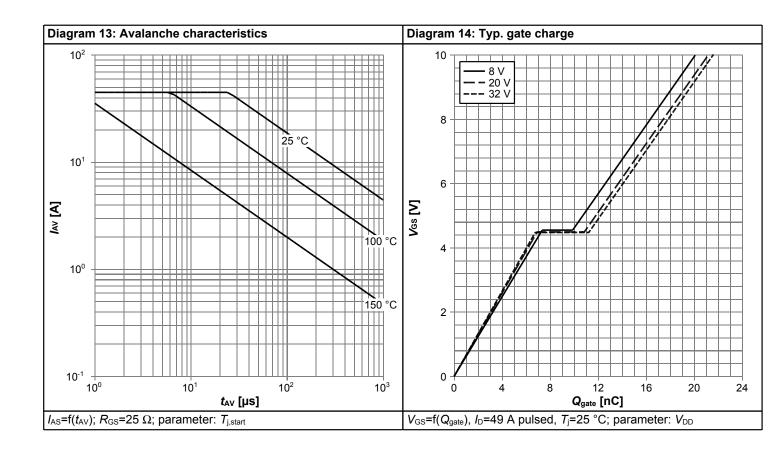


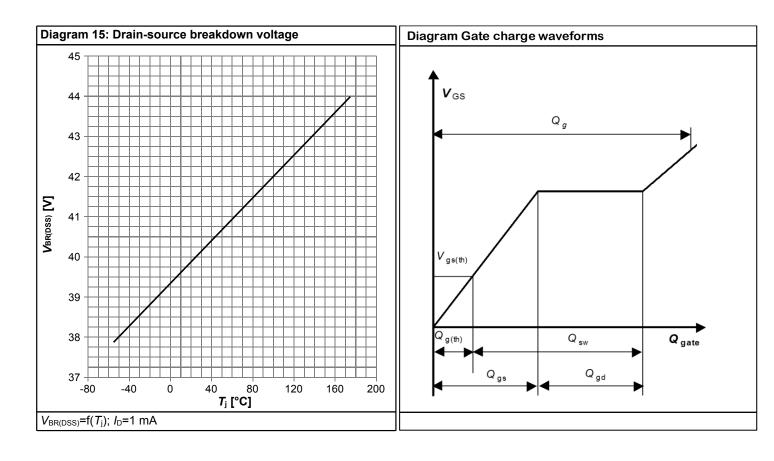






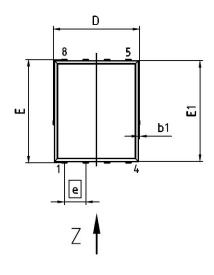


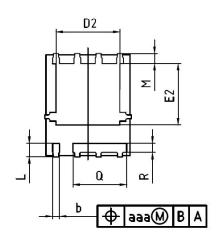


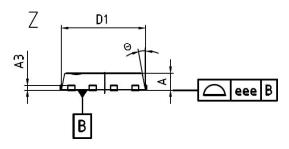




5 Package Outlines







DIM	MILLI	METERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	0.90	1.10	0.035	0.043	
A3	0.25	(REF)	0.011	(REF)	
b	0.34	0.54	0.013	0.021	
b1	0.02	0.22	0.001	0.009	
D	5.15	(BSC)	0.203	(BSC)	
D1	5.00	(BSC)	0.197	(BSC)	
D2	3.70	4.40	0.146	0.173	
E	6.15	(BSC)	0.242 (BSC)		
E1	6.00	(BSC)	0.236 (BSC)		
E2	3.40	3.80	0.134	0.150	
е	1.27	(BSC)	0.050 (BSC)		
N		8	8		
L	0.74	0.84	0.029	0.033	
М	0.45	0.66	0.018	0.026	
Θ	8.5°	12°	8.5°	12°	
Q	3.15	3.25	0.124	0.128	
R	0.48	0.58	0.019	0.023	
aaa	C).25	0.	010	
eee	0	0.08	0	003	

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REVISION 01	

Figure 1 Outline TDSON-8 FL, dimensions in mm/inches

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Revision History

ISC036N04NM5

Revision: 2020-03-23, Rev. 2.1

Previous Revision

1 10110401	Torrodo Nevicion						
Revision	Date	te Subjects (major changes since last revision)					
2.0	2020-02-04	Release of final version					
2.1	2020-03-23	Update condition Id pulse, Features and footnotes					

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